

1-Line Ultra Low Capacitance Bi-directional TVS Diode

Features

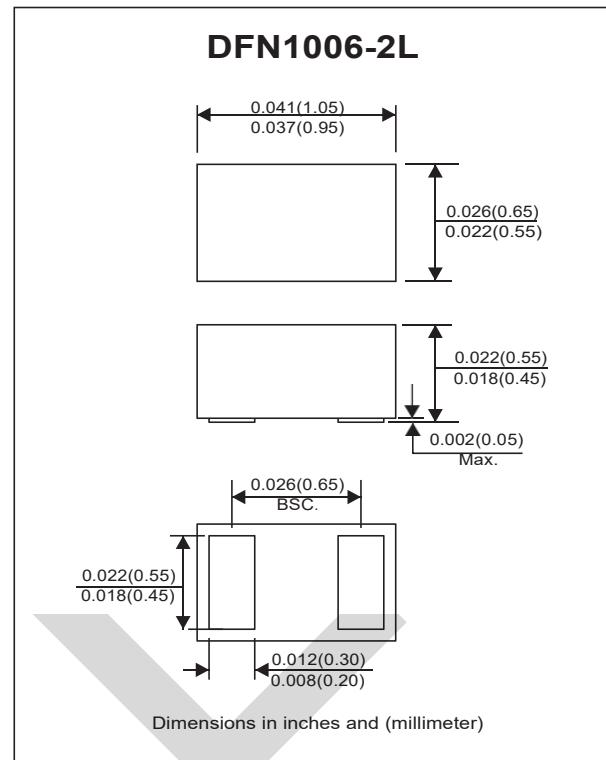
- IEC 61000-4-2 (ESD) $\pm 25\text{kV}$ (air), $\pm 22\text{kV}$ (contact)
- IEC 61000-4-5 (lightning): 4A (8/20 μs)
- Ultra small package: 1.0x0.6x0.5mm
- Ultra low capacitance: 0.3pF typical
- Ultra low leakage: nA level
- Operating voltage: 3.3V
- Low clamping voltage
- 2-pin leadless package

Mechanical Characteristics

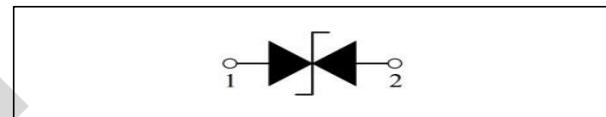
- Package: DFN1006-2L (1.0×0.6×0.5mm)
- Case Material: "Green" Molding Compound
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminal Connections: See Diagram Below
- Marking Information: See Below

Applications

- Cellular Handsets and Accessories
- Display Ports
- MDDI Ports
- USB Ports
- Digital Visual Interface (DVI)
- PCI Express and Serial SATA Ports



Circuit Diagram

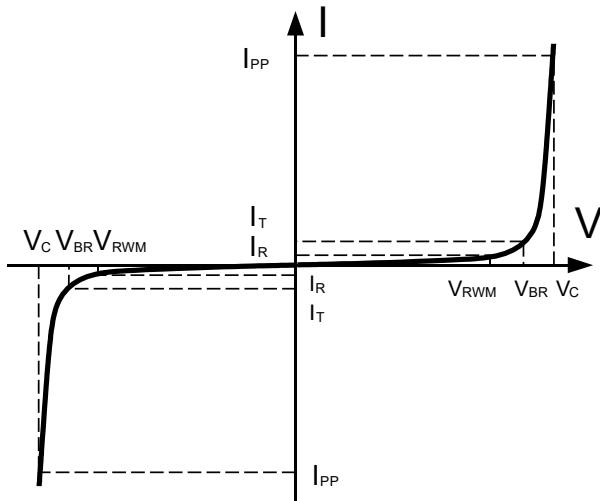


Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Peak Pulse Power (8/20 μs)	P_{pk}	100	W
Peak Pulse Current (8/20 μs)	I_{PP}	4	A
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V_{ESD}	± 25 ± 22	kV
Operating Temperature Range	T_J	-55 to +125	°C
Storage Temperature Range	T_{stg}	-55 to +150	°C

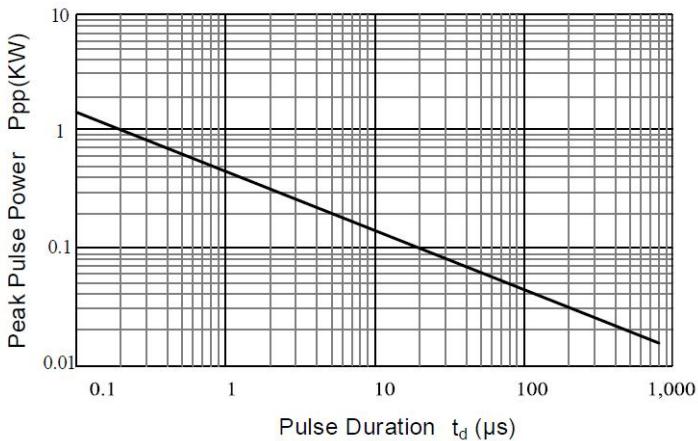
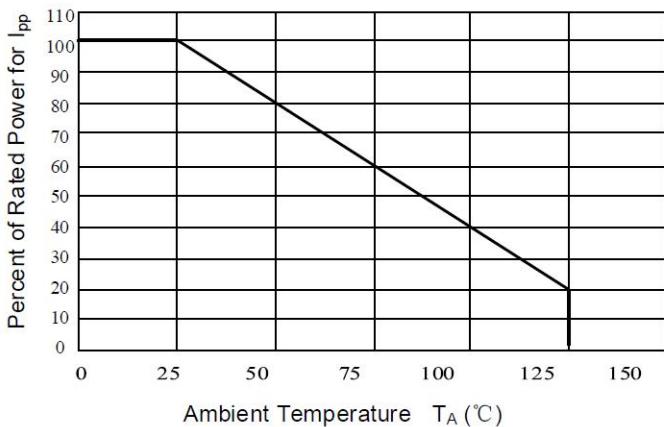
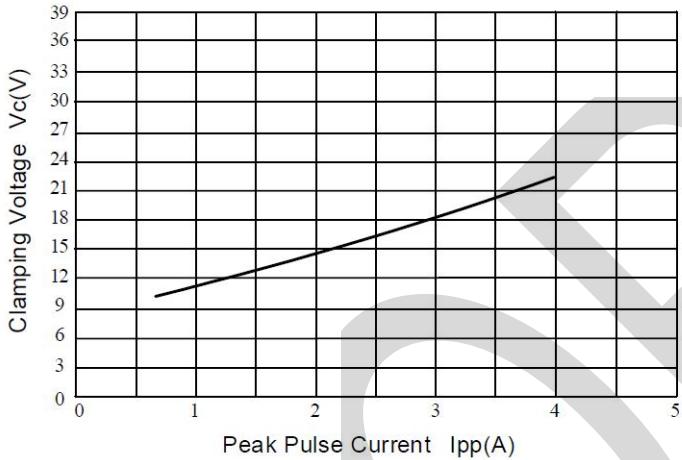
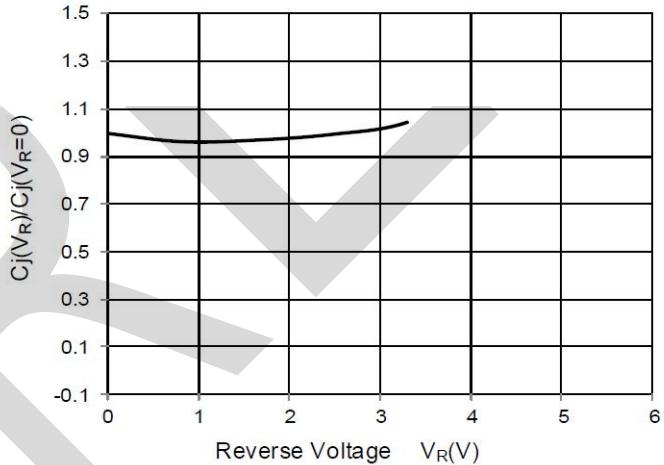
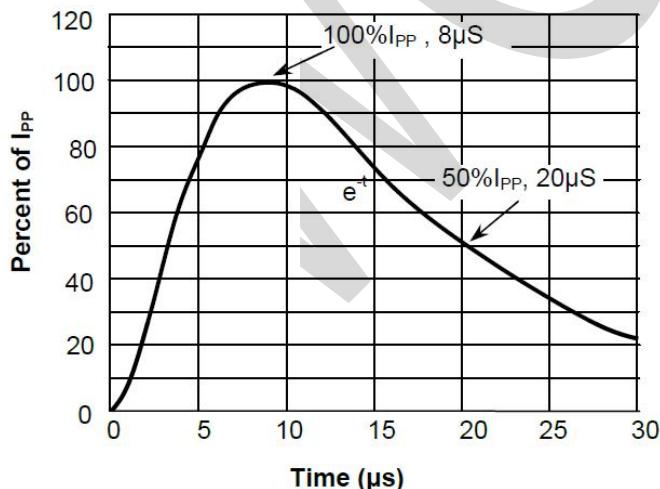
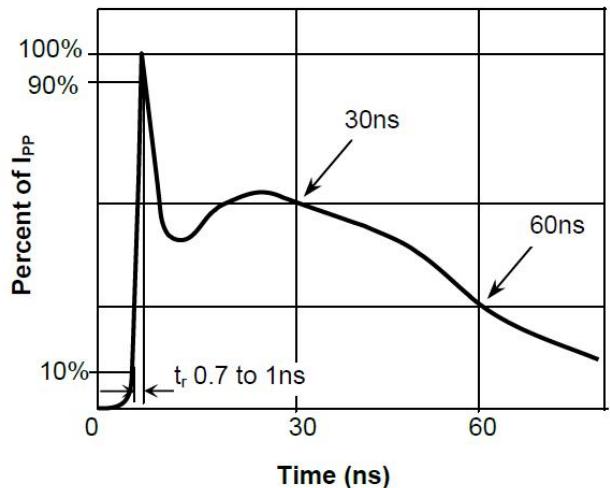
Electrical Parameters ($T=25^{\circ}\text{C}$)

Symbol	Parameter
I_{PP}	Reverse Peak Pulse Current
V_C	Clamping Voltage @ I_{PP}
V_{RWM}	Reverse Stand-Off Voltage
I_R	Reverse Leakage Current @ V_{RWM}
V_{BR}	Breakdown Voltage @ I_T
I_T	Test Current



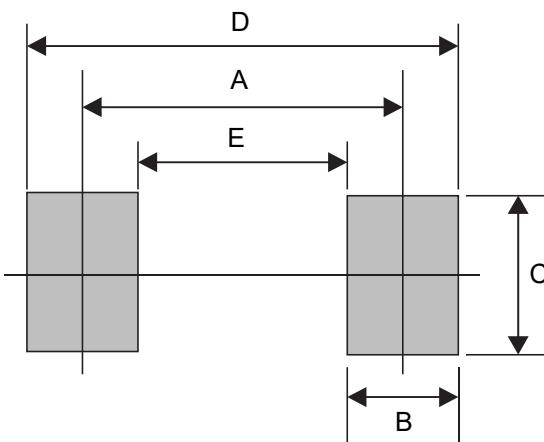
Electrical Characteristics ($T_A = 25^{\circ}\text{C}$, unless otherwise specified)

Parameter	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Working Voltage	V_{RWM}			3.3	V	
Breakdown Voltage	V_{BR}	4.5			V	$I_T = 1\text{mA}$
Reverse Leakage Current	I_R			0.1	μA	$V_{RWM} = 3.3\text{V}$
Clamping Voltage	V_C			12	V	$I_{PP} = 1\text{A}$ (8 x 20 μs pulse)
Clamping Voltage	V_C			25	V	$I_{PP} = 4\text{A}$ (8 x 20 μs pulse)
Junction Capacitance	C_J		0.3	0.5	pF	$V_R = 0\text{V}$, $f = 1\text{MHz}$

Typical Performance Characteristics ($T_A=25^\circ\text{C}$ unless otherwise Specified)

Fig 1. Peak Pulse Power vs. Pulse Time

Fig 2. Power Derating Curve

Fig 3. Clamping Voltage vs. Peak Pulse Current

Fig 4. Junction Capacitance vs. Reverse Voltage

Fig 5. 8 X 20μs Pulse Waveform

Fig 6. ESD(IEC61000-4-2) Pulse Waveform

Suggested PAD Layout

SIZE	DFN1006-2L	
	(mm)	(inch)
A	0.70	0.028
B	0.40	0.016
C	0.60	0.024
D	1.10	0.043
E	0.30	0.012



Marking Code

Part Number	Marking Code
WESD3V31CUY	21

21

Ordering Information

Part Number	Package	Base qty	Reel Size	Delivery mode
		(pcs)	(inch)	
WESD3V31CUY	DFN1006-2L	10,000	7	Tape and reel

Description of model and identification

